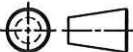



1. Material: C7701, T=0.15mm, 1/2H
2. Plating: Tin 50-100 μ over Ni flash
3. Grain Direction: Not Required.
4. Stamping Direction: Noted in the drawing.
5. Burr Height: 0.05mm Max.
6. Min. Cutting Radius: R0.15mm
7. Min. Bending Radius: R0.10mm

1	SHIELD WBZ451	S.T.D.	CRS 1008/1010	1
ITEM	PARTS NAME	HARDNESS	MATERIALS	QTY.REQ.
LIST OF MATERIALS AND APPLICABLE DOCUMENTS				
ALL DIMENSIONAL IN UNITS MM.	TOL: .X ±0.1 .XX ±0.01 .XXX ±0.005 XXXX ±0.0025 XXX ±0.005 XXX ±0.005	DRAWN: P. R+	DRAWING NAME: SHIELD WBZ451	
PROJECTION UNLESS SPECIFIED 		DATE: DEC.13,2021	TITLE REFERENCE: SHIELD WBZ451	
 MICROCHIP (MMT FACTORY)		PANUSAK I.		
		APPROVED: NUTTHIWUT Y.	DRAWING NUMBER DWG-B32-022	
		REVISION A	SHEET 1 of 1	PAPERS A4
				SCALE 8:1